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(54) Title: **MULTILAYERED POLYMERIC STRUCTURE**

(57) Abstract: A multilayered polymeric structure having at least two polymeric layers is provided, each layer being a mixture of a polymeric composition with carbon fibrils. The multilayer polymeric structure may include an electrically conductive material between the first and second polymeric layers. A process for making a multilayered polymeric structure for packaging electronic components is also provided. The multilayered polymeric material is used to form trays and packages for containing electrical components.

MULTILAYERED POLYMERIC STRUCTURE

BACKGROUND OF THE INVENTION

Field of Invention

The invention relates generally to electrically conductive polymers and more particularly to antistatic and electrically protective packaging made of multilayered polymeric materials.

Description of the Related Art

Antistatic materials

The sudden discharge of static electricity which may build on a sensitive electrical component often results in current flow through the component far exceeding its current carrying capacity. In order to protect and avoid the damage or destruction of such components, slow dissipation of the static charge from these components is crucial. For this reason, static-sensitive components are typically transported and stored on trays or in containers made of "antistatic" material having a very high resistance. The high resistance of the material allows electric charge to flow through the material only at very low current levels.

Static charges can also impact the quality of signals carried in cables. Static charges can induce or modify electrical fields affecting nearby electrical signals. Antistatic layers can be incorporated into signal cables to minimize effects of nearby static charges.

Antistatic materials used to transport or store static sensitive components are generally characterized by a uniform electrically conductive surface having resistance in the range of 1×10^6 to 1×10^{10} ohms per square. Although polymers are generally nonconductive, sheets of polymeric compositions containing conductive impurities or additives may be made to conduct electricity, and may be used as antistatic materials. The additives discussed include but are not limited to metallic powders, metallic fibers, ionic conductive polymers, intrinsically conductive polymeric powder (e.g., polypyrrole), carbon fibers or carbon black.

Although prior art packages and trays made of polymeric material are suitable for dissipating electric charge from sensitive components, they do not protect the components from electric charge originating outside of the tray or package. If a conventional tray or package of the prior art comes in contact with a current source having sufficiently high voltage, electric current can flow through the tray or package, and through the components therein, damaging the components. Trays and packages made from the single layer polymeric materials of the prior art provide no means for shunting current away from the components, and therefore are not suitable for protecting components against charge emanating outside the tray or package. Further, the effectiveness of single layer materials of the prior art may be limited to specific ranges of voltage or frequency.

Carbon Nanotubes

This invention lies in the field of submicron graphitic carbon fibrils, sometimes called vapor grown carbon fibers or nanotubes. Carbon fibrils are vermicular carbon deposits having diameters less than 1.0μ , preferably less than 0.5μ , and even more preferably less than 0.2μ . They exist in a variety of forms and have been prepared through the catalytic decomposition of various carbon-containing gases at metal surfaces. Such vermicular carbon deposits have been observed almost since the advent of electron microscopy. (Baker and Harris, Chemistry and Physics of Carbon, Walker and Thrower ed., Vol. 14, 1978, p. 83; Rodriguez, N., J. Mater. Research, Vol. 8, p. 3233 (1993)).

In 1976, Endo et al. (see Oberlin, A. and Endo, M., J. of Crystal Growth, Vol. 32 (1976), pp. 335-349), hereby incorporated by reference, elucidated the basic mechanism by which such carbon fibrils grow. They were seen to originate from a metal catalyst particle, which, in the presence of a hydrocarbon containing gas, becomes supersaturated in carbon. A cylindrical ordered graphitic core is extruded which immediately, according to Endo et al., becomes coated with an outer layer of pyrolytically deposited graphite. These fibrils with a pyrolytic overcoat typically have diameters in excess of 0.1μ , more typically 0.2 to 0.5μ .

In 1983, Tennent, U.S. Patent No. 4,663,230, hereby incorporated by reference, describes carbon fibrils that are free of a continuous thermal carbon overcoat and have multiple graphitic outer layers that are substantially parallel to the fibril axis. As such they may be characterized as having their cylindrical axes, the 5 axes which are perpendicular to the tangents of the curved layers of graphite, substantially perpendicular to their cylindrical axes. They generally have diameters no greater than 0.1μ and length to diameter ratios of at least 5. Desirably they are substantially free of a continuous thermal carbon overcoat, i.e., pyrolytically deposited carbon resulting from thermal cracking of the gas feed used to prepare 10 them. Thus, the Tennent invention provided access to smaller diameter fibrils, typically 35 to 700Å (0.0035 to 0.070 μ) and to an ordered, "as grown" graphitic surface. Fibrillar carbons of less perfect structure, but also without a pyrolytic carbon outer layer have also been grown.

The carbon nanotubes which can be oxidized as taught in this application, are 15 distinguishable from commercially available continuous carbon fibers. In contrast to these fibers which have aspect ratios (L/D) of at least 10^4 and often 10^6 or more, carbon fibrils have desirably large, but unavoidably finite, aspect ratios. The diameter of continuous fibers is also far larger than that of fibrils, being always $>1.0 \mu$ and typically 5 to 7 μ .

20 Tennent, et al., US Patent No. 5,171,560, hereby incorporated by reference, describes carbon fibrils free of thermal overcoat and having graphitic layers substantially parallel to the fibril axes such that the projection of said layers on said fibril axes extends for a distance of at least two fibril diameters. Typically, such fibrils are substantially cylindrical, graphitic nanotubes of substantially constant 25 diameter and comprise cylindrical graphitic sheets whose c-axes are substantially perpendicular to their cylindrical axis. They are substantially free of pyrolytically deposited carbon, have a diameter less than 0.1μ and length to diameter ratio of greater than 5. These fibrils can be oxidized by the methods of the invention.

When the projection of the graphitic layers on the nanotube axis extends for a 30 distance of less than two nanotube diameters, the carbon planes of the graphitic

nanotube, in cross section, take on a herring bone appearance. These are termed fishbone fibrils. Geus, U.S. Patent No. 4,855,091, hereby incorporated by reference, provides a procedure for preparation of fishbone fibrils substantially free of a pyrolytic overcoat. These carbon nanotubes are also useful in the practice of the invention.

Carbon nanotubes of a morphology similar to the catalytically grown fibrils described above have been grown in a high temperature carbon arc (Iijima, Nature, 354, 56, 1991). It is now generally accepted (Weaver, Science, 265, 1994) that these arc-grown nanofibers have the same morphology as the earlier catalytically grown fibrils of Tennent. Arc grown carbon nanofibers after colloquially referred to as "bucky tubes", are also useful in the invention.

Carbon nanotubes differ physically and chemically from continuous carbon fibers which are commercially available as reinforcement materials, and from other forms of carbon such as standard graphite and carbon black. Standard graphite, because of its structure, can undergo oxidation to almost complete saturation. Moreover, carbon black is amorphous carbon generally in the form of spheroidal particles having a graphene structure, carbon layers around a disordered 20 nucleus. The differences make graphite and carbon black poor predictors of nanotube chemistry.

20

Aggregates of Carbon Nanotubes

As produced carbon nanotubes may be in the form of discrete nanotubes, aggregates of nanotubes or both.

Nanotubes are prepared as aggregates having various morphologies (as determined by scanning electron microscopy) in which they are randomly entangled with each other to form entangled balls of nanotubes resembling bird nests ("BN"); or as aggregates consisting of bundles of straight to slightly bent or kinked carbon nanotubes having substantially the same relative orientation, and having the appearance of combed yarn ("CY") e.g., the longitudinal axis of each nanotube (despite individual bends or kinks) extends in the same direction as that of the surrounding nanotubes in the bundles; or, as, aggregates consisting of straight to

slightly bent or kinked nanotubes which are loosely entangled with each other to form an "open net" ("ON") structure. In open net structures the extent of nanotube entanglement is greater than observed in the combed yarn aggregates (in which the individual nanotubes have substantially the same relative orientation) but less than
5 that of bird nest.

The morphology of the aggregate is controlled by the choice of catalyst support. Spherical supports grow nanotubes in all directions leading to the formation of bird nest aggregates. Combed yarn and open nest aggregates are prepared using supports having one or more readily cleavable planar surfaces, e.g., an iron or
10 iron-containing metal catalyst particle deposited on a support material having one or more readily cleavable surfaces and a surface area of at least 1 square meters per gram. Moy et al., U.S. Application Serial No. 08/469,430 entitled "Improved Methods and Catalysts for the Manufacture of Carbon Fibrils", filed June 6, 1995, hereby incorporated by reference, describes nanotubes prepared as aggregates having
15 various morphologies (as determined by scanning electron microscopy).

Further details regarding the formation of carbon nanotube or nanofiber aggregates may be found in the disclosure of U.S. Patent No. 5,165,909 to Tennent; U.S. Patent No. 5,456,897 to Moy et al.; Snyder et al., U.S. Patent Application Serial No. 07/149,573, filed January 28, 1988, and PCT Application No. US89/00322, filed
20 January 28, 1989 ("Carbon Fibrils") WO 89/07163, and Moy et al., U.S. Patent Application Serial No. 413,837 filed September 28, 1989 and PCT Application No. US90/05498, filed September 27, 1990 ("Battery") WO 91/05089, and U.S. Application No. 08/479,864 to Mandeville et al., filed June 7, 1995 and U.S. Application No. 08/284,917, filed August 2, 1994 and U.S. Application No.
25 08/320,564, filed October 11, 1994 by Moy et al., all of which are assigned to the same assignee as the invention here and are hereby incorporated by reference.

OBJECTS OF THE INVENTION

It is therefore an object of the invention to provide an improved packaging material which will protect sensitive electric components from damage or
30 destruction due to electrostatic discharge.

It is a further object of the invention to provide improved packages and carrying trays for electrical components..

It is a further object of the invention to provide improved shielding for signal carrying cables.

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SUMMARY OF THE INVENTION

A packaging material is provided having multiple polymeric layers. Each layer comprises a mixture of a polymer and carbon fibrils. The multilayered material has an inner layer with a uniform surface resistance in the range of 1×10^6 ohms per square to 1×10^{10} ohms per square, and an outer layer with a surface resistance lower than that of the inner layer. The inner and outer layers may be directly in contact with one another, or there may be intermediate layers of conductive material between them. Each intermediate layer could be made of any material having a surface resistance of at least 10^{10} ohms per square. The surface resistance of the packaging material varies from $10^{0.5}$ to 10^{10} ohms per square, preferably from 10^1 to 15 10^8 ohms per square.

In a two-layer polymeric structure, the first layer contains a polymer having 0.25% to 25% by weight of carbon fibrils. This concentration of fibrils provides the antistatic layer with a surface resistance in the range of 1×10^6 to 1×10^{10} ohms per square. The second layer may contain 2% to 35% by weight of carbon fibrils, thereby providing a lower resistance relative to the first antistatic layer. Each polymeric layer can have a thickness from about 0.5 mils to about 175 mils and preferably from about 5 mils to about 30 mils. The entire multilayered polymeric structure can be of whatever thickness is desirable for a given application. For example, the structure of the invention can be from about 1 mil to about 250 mils, 25 preferably from about 2 mils to about 100 mils and most preferably from about 10 mils to about 60 mils.

Once each of the polymeric compositions comprising the various layers of the invention are prepared, they are combined to form a composite multilayered material. If the separate layers of polymeric composition are allowed to 30 cure prior to being joined, the combining process consists of applying heat and

pressure which causes the separate layers to fuse together. It is, however, preferred that the separate layers of polymeric material are joined prior to curing. This may be accomplished via a coextrusion process, where two or more polymeric compositions are forced through a single aperture. The multilayered material produced by 5 coextrusion may either be allowed to cure as a flat sheet, or may be placed into molds in the form of a desired end-product, i.e. a tray. Each polymeric layer can be processed according to any applicable kind of polymer processing, it being understood that the carbon fibril loading does not limit its processability.

As used herein to "cure" or "curing" refers to a process of conversion 10 of raw or reactive polymer systems to a finished and useful condition usually by transfer of heat and/or application of chemicals which induce physical and/or chemical changes. Cooling of a molten polymeric composition into a solid layer or sheet is an example of curing. Another example of curing is the process of crosslinking a thermosetting product.

15 The polymeric material of the invention may be formed into any one of a number of shapes or configurations suitable for the transport and/or storage of sensitive electrical components, i.e. trays and packages. When the material of this invention is formed into a tray or package, the antistatic layer of the material is situated such that it faces the inside of the tray or package, and comes directly in 20 contact with the component. A more conductive polymeric layer of the material forms the outside surface of the tray or package.

An advantage of having the outer layer of the multilayered material more conductive than the inside antistatic layer is that the outer layer acts as a shunt for any electric current originating outside of a tray or package made of the material. 25 Should a source of electric charge come in contact with the outside surface of a tray or package made of the multilayered material, the outer layer will conduct the current to a point on the outer surface where the current may leave the material. The relatively higher resistance of the inner antistatic layer impedes current flow through that layer and into components which may be present on the other side.

The multilayer materials can be used in other applications where a gradient in electrical properties is desired. Changes in the concentration of fibrils can lead to changes in both the conductivity and the permittivity of the resulting composite. Other applications include: dielectric lenses made of layers with different levels of carbon fibrils; field limiting insulation layers for cables or electronic parts; and selective shielding or EMI bandpass filters for cables or signal carrying lines.

In these examples, the different levels of carbon fibrils in the layers asymmetrically modifies the flow of current or charge perpendicular to the layers or modifies electrical fields.

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BRIEF DESCRIPTION OF THE FIGURES

Fig. 1 shows a cross-section of a two layer polymeric material according to the invention.

Fig. 2 shows a tray made from the two layer polymeric material of Fig. 1.

15

Fig. 3 shows two layers made of polymeric compositions having fibrils therein being combined to form the two layer conductive polymeric material of Fig. 1.

Fig. 4 is a test set-up diagram of a molded tensile bar utilized for measuring DC resistance through the volume of samples in example 1 to 9.

DETAILED DESCRIPTION OF THE INVENTION

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In a preferred embodiment of the invention, the material has two layers, as shown in the cross-sectional view of Fig. 1. The polymeric material 1 of the invention is a composite of a first layer 1a and a second layer 1b, each layer being a mixture of carbon fibrils in a polymer. The electrical resistance of each polymeric composition is inversely related to the concentration of fibrils in the composition, i.e., the higher the concentration of fibrils, the lower the electrical resistance of the composition. Therefore, the first layer 1a of polymeric material, with a 2.5% by

weight concentration of carbon fibrils, has a surface resistance of about 1×10^7 ohms per square. The second layer lb, having a fibril concentration of 5.0% has a surface resistance of only about 1×10^4 ohms per square.

- Carbon fibrils are typically in the form of vermicular tubes with
- 5 graphitic outer layers disposed substantially concentrically about the cylindrical axis of the fibril. Preferably, the fibrils are substantially free of a pyrolytically deposited thermal carbon overcoat.

Carbon fibrils have a length-to-diameter ratio of at least 5, and more preferably at least 100. Carbon fibrils are carbon filaments having diameters less than

10 500 nanometers. Even more preferred are fibrils whose length-to-diameter ratio is at least 1000. The wall thickness of the fibrils is about 0.1 to 0.4 times the fibril external diameter which is preferably between 3.5 and 75 nanometers. In applications where high strength fibrils are needed, e.g., where the fibrils are used as reinforcements, the external fibril diameter is substantially constant over its length.

15 Generally, preferred classes of polymers used for this invention include thermosets, thermoplastics, elastomers and inorganics. Certain polymeric alloys, defined as two or more miscible or partially miscible polymers, and blends, defined as discrete non-miscible phases, are also preferred. Specific examples of thermosets and elastomers include polyurethanes, natural rubber, synthetic rubber, epoxy, phenolic, polyesters, polyamides, and silicones. Specific examples of thermoplastics include polyacetal, polyacrylic, acrylonitrile-butadiene-styrene, polycarbonates, polystyrenes, polyethylene, styrene acrylonitrile, polypropylenes, polyethylene terephthalate, polybutylene terephthalate, polyamide (6, 6/6, 6/10, 6/12, 11 or 12), polyamide-imides, polyarylates, polyurethanes, thermoplastic olefins (i.e.,

20 polypropylene/impact modifiers such as ethylene, propylene and rubber), thermoplastic elastomers, polyarylsulfone, polyethersulfone, polyphenylene sulfide, polyvinyl chloride, chlorinated polyvinyl chloride, polysulfone, polyetherimide, polytetrafluoro ethylene, fluorinated ethylene propylene, perfluoroalkoxy, polychlorotrifluoro ethylene, ethylene tetrafluoro ethylene, polyvinylidene fluoride,

25 polyvinyl fluoride, polyetherketone, polyether etherketone and polyether ketone ether

ketone. Specific examples of alloys and blends include acrylonitrile-butadiene-styrene/polyamide, polycarbonate/acrylonitrile-butadiene-styrene, acrylonitrile butadiene styrene/polyvinyl chloride, polyphenylene ether/polystyrene, polyphenylene ether/polyamide, polysulfone/acrylonitrile-butadiene-styrene, 5 polycarbonate/thermoplastic urethane, polycarbonate/polyethylene terephthalate, thermoplastic elastomer alloys, polyamide/elastomers, polyester/elastomers, polyethylene terephthalate/polybutyl terephthalate, acetal/elastomer, styrene-maleic-anhydride/acrylonitrile-butadiene-styrene, polyether etherketone/polyethersulfone, polyethylene/polyamide and polyethylene/acetal.

10 Specific examples of inorganic polymers include phosphorus based compounds and silicones.

In a preferred embodiment of the invention, the polymer comprises a blend of polymers possessing advantageous properties and a compatibilizer or a compatibilizer with a modifying resin for facilitating the blending of the polymers.

15 Specific examples of such blends include polyphenylene ethers (PPE) or polyphenylene oxides (PPO) with polyamides (e.g., nylons) or polycarboxylic reactants. Examples of such polymer blends with compatibilizers or compatibilizers and modifying agents are described in U.S. Pat. Nos. 4,988,775 and 5,132,365 and in European Patent Application Nos. 90124310.5, 90300841.5, 91112496.4 and 20 92109100.5.

The polymeric compositions comprising each of the various layers of the multilayered structure of this invention are made by known methods, such as those described in U.S. Pat. Nos. 5,643,502, 5,651,922 and 5,591,382 to Nahass et al. U.S. Patent Nos. 5,591,382; 5,651,922; and 5,643,502 all to Nahass et al. disclose a 25 polymeric composition having improved toughness and conductivity which includes carbon fibrils, at least a portion of which are in the form of aggregates, substantially all of which aggregates are less than 35 pm in diameter. A method for preparing this polymeric composition is also disclosed. The method includes mixing the carbon fibrils, most of which are in the form of aggregates, with a polymeric material by 30 applying shear to break down the aggregates and distribute them in the polymeric

material until substantially all of the aggregates are less than 35 pm in diameter. The patents to Nahass et al. are incorporated herein by reference as if set forth in full.

One method of combining layers 1a and 1b involves first shaping each of the compositions into individual flat sheets and allowing the sheets to cure. After 5 curing, the sheets are pressed together under conditions of high heat and pressure, causing them to fuse to one another. Conductive adhesives may also be used to join separate sheets of polymeric composition to one another.

Another method is to insert or over-mold the two layers. In this process an injection molding machine is used to mold the first layer. The resultant 10 part is then placed into a second mold where the second layer is then molded onto the first. The heat from the second layer causes a melt-bond to form between the first and second layers. In this way the layers are cured sequentially. The same effect can also be achieved using a special two-shot or multi-shot molding machine. This is an apparatus that has two or more barrels that inject polymeric materials into the same 15 mold. Materials with different conductivities are placed in different barrels and injected into the mold separately to form a two or more layered part.

Once the polymeric compositions constituting each of the layers of the multilayered polymer structure are prepared, they are preferably combined in a coextrusion process as schematically depicted in Fig. 3.

20 In this preferred process, two or more viscous materials are combined into a multilayered product. The polymeric compositions of the first and second layers 1a and 1b are forced through an aperture before either composition has had a chance to cure. This forms a multilayered sheet of polymeric compositions which can be placed in a mold. A similar process can be used to coextrude multilayer tubes or 25 jackets for cables or wires.

Fig. 2 shows a tray 3 made from the multilayered material of this invention. The first layer 1a of the material forms the inside antistatic surface of the tray 3. A carbon fibril concentration of 2.5% by weight provides the inside layer with a surface resistance of about 1×10^7 ohms per square. The high level of surface

resistance of the inside layer 1a allows for the slow dissipation of any electro-static charge which may build on components present inside the tray 3. This charge is dissipated through the outer layer 1b which is in electrical contact with the inner layer 1a.

5 The second layer 1b forms the outside surface of the tray 3 and has a surface resistance of about 1×10^4 ohms per square. The second layer contains about 5% by weight of carbon fibrils, and due to the lower resistance of layer 1b relative to 1a, layer 1b reduces the risk of electrical charge flowing from outside the tray into the tray and damaging components therein. Layer 1b acts as a shunt guiding current away
10 from the sensitive components inside the tray. Item 4 in Fig. 2 represents an electrical component which can be carried by using tray 3.

15 The multilayered polymeric material of this invention may be formed into any shape or configuration including trays, packages, boxes, and the like by injection molding, blow molding, RIM, or any other method commonly known for shaping polymeric materials. The antistatic properties of the packaging material of the invention are measured according to the procedure described in ASTM D-257.

EXAMPLES

20 The following examples serve to provide further appreciation of the invention but are not meant in any way to restrict the effective scope to the invention.

Examples 1- 9

Masterbatch compositions containing 15% fibril loading were prepared according to methods described in the examples section of U.S. Patent No. 5,651,922 to Nahass et al. incorporated herein by reference. Masterbatch formulations were
25 prepared having 15% by weight carbon fibrils obtained from bird's nest (BN) aggregates and 85% polyethylene terephthalate modified with cyclohexanedimethanol (PETG). Other masterbatch compositions included 15% by weight carbon fibrils from bird's nest type aggregates and 85% polybutylene terephthalate (PBT). Yet other masterbatch composition were prepared to include 15% by weight carbon fibrils from

bird's nest type aggregates and 0.5% by weight polytetrafluoroethylene (PTFE) and the balance PETG.

The above masterbatch compositions were used to make other formulations as listed in Table 1 below. For example, to make a PETG/SBN product
 5 33.5% PBT/15BN was mixed with 66.7% PETG polymer. PBT and PETG trans-esterify to form a hybrid mixture of two polymers with a single flow transition temperature and are crystalline in nature. The impact modifier (IM) used in these formulations was rubber. For example, formulation 7 of table 1 contains 2% by weight impact modifier, 5% by weight carbon fibrils from bird's nest aggregates and a
 10 hybrid mixture of 28 wt% PBT and 65 wt% PETG. Electrical properties for each formulation, such as volume and surface resistivity were measured and are listed for each formulation in Table 1 below.

Table 1

Example	Formulation	Masterbatch	Volume Resistivity ohm- cm	Surface Resistivity ohm/square
1	PETG/2IM/5BN	PETG/15BN	6.63E+02	2.86E+05
2	PETG/4 IM/SBN	PETG/15BN	5.80E+02	7.71E+06
3	PETG/6 IM/5BN	PETG/15BN	9.30E+02	8.00E+06
4	PETG/2IM/5BN	PETG/0.5PTFE/15BN	2.30E+03	1.90E+06
5	PETG/4IM/5BN	PETG/0.5PTFE/15BN	6.80E+02	3.70E+06
6	PETG/6IM/SBN	PETG/0.5PTFE/15BN	1.40E+02	4.00E+06
7	PETG/2IM/5BN	PBT/15BN	1.00E+02	3.90E+05
8	PETG/4IM/5BN	PBT/15BN	8.74E+02	1.17E+07
9	PETG/6IM/5BN	PBT/15BN	8.46E+02	8.57E+04

DC resistance through the volume of the samples was measured at 2
 15 volts and converted to volume resistivity using the formula shown with the test set-up diagram in Figure 4. Electrodes were painted on each end 1 of injection molded tensile bars with silver conducting paint after cutting away the tabs from each end. The leads of a multi-meter were then contacted with the silver paint electrode strips 2a and 2b on the sample in order to obtain surface resistivity measurements and with the
 20 silver paint electrode strips 3a and 3b in order to obtain volume resistivity measurements. In Figure 4, d is the electrode spacing for surface resistivity test, 1 is the electrode spacing for volume resistivity test, w is the electrode width and t is the

sample thickness, all values are measured in centimeters. Based on the foregoing variables, the surface and volume resistivity are calculated as follows:

$$\text{surface resistivity (ohm/square)} = \text{resistance [ohm]} / (d [\text{cm}] / w [\text{cm}])$$

$$\text{volume resistivity (ohm-cm)} = \text{resistance [ohm]} \times t [\text{cm}] / (1[\text{cm}] / w [\text{cm}])$$

5

Discussion of Experimental Results

Any one of the formulations above can be combined with another to form a bilayered polymeric structure useful in forming the packaging material of the present invention. For example, a bilayered polymeric structure can be made by 10 coextrusion or lamination with a conductive adhesive between the layers by overmolding or by two-shot molding. The resulting bilayered structure is then thermoformed into a tray wherein the layer prepared from composition 1 is the inside layer having the higher surface resistivity.

Although the invention has been described with reference to specific 15 examples, they should not be construed as limiting since they are merely illustrative of the invention. One of skill in the art may alter the described examples without departing from the spirit or scope of the invention

We claim:

1. A multilayered polymeric structure for protecting electronic components comprising at least a first polymeric layer and a second polymeric layer in surface contact with one another, said first and second polymeric layers each containing a different amount of carbon fibrils.
2. The multilayered polymeric structure according to claim 1, wherein said first and said second polymeric layers each comprise from about 0.25% to about 35% by weight of carbon fibrils.
3. The multilayered polymeric structure according to claim 1, wherein said first and said second polymeric layers each comprise from about 1.0% to about 15% by weight of carbon fibrils.
4. The multilayered polymeric structure according to claim 1, wherein said first and said second polymeric layers each comprise from about 2.0% to about 7% by weight of carbon fibrils.
- 15 5. The multilayered polymeric structure according to claim 1, wherein said first polymeric layer comprises from about 0.25% to about 25% by weight of carbon fibrils and said second polymeric layer comprises from about 2% to about 35% by weight of carbon fibrils.
- 20 6. The multilayered polymeric structure according to claim 1, further comprising at least an electrically conductive material between said first polymeric layer and said second polymeric layer.
7. The multilayered polymeric structure according to claim 6, wherein the electrically conductive material is an adhesive.
- 25 8. The multilayered polymeric structure according to claim 1, wherein the surface resistance in said second polymeric layer is at least one order of magnitude greater than the surface resistance of said first polymeric layer.

9. The multilayered polymeric structure according to claim 1, wherein the surface resistance of each of said polymeric layers is in the range of 1×10^1 ohms per square to 1×10^{12} ohms per square.

10. The multilayered polymeric structure according to claim 9, wherein the 5 surface resistance of said second polymeric layer is in the range of 1×10^1 to 1×10^6 ohms per square.

11. The multilayered polymeric structure according to claim 9, wherein the 10 surface resistance of said first polymeric layer is in the range of 1×10^6 ohms per square to 1×10^{12} ohms per square.

12. A process for making a multilayered polymeric structure for protecting 10 an electronic component which comprises:

(a) forming at least a first polymeric layer and a second polymeric layer, each layer comprising a different amount of carbon fibrils;

15 (b) combining said first and second polymeric layer to form said multilayered polymeric structure.

13. The process according to claim 12, wherein said first and second polymeric layers comprise from about 0.25% to about 35% by weight of carbon fibrils.

14. The process according to claim 12, wherein said first polymeric layer 20 comprises from 0.25 to 25% by weight carbon fibrils and said second polymeric layer comprises from 2% to 35% by weight carbon fibrils.

15. The process according to claim 12, wherein said layers are combined by coextrusion or lamination, or by two shot or multi-shot injection molding or by insert injection molding.

25 16. The process according to claim 12, wherein said first polymeric layer has a higher surface resistance than said second polymeric layer.

17. The process according to claim 16, wherein said multilayered polymeric structure is formed into a tray or packaging material, wherein said electronic component is in contact with said first polymeric layer.

18. The process according to claim 16, further comprising forming third 5 polymeric layer in surface contact with said first or said second polymeric layer, said third polymeric layer comprising from about 0.25% to about 35% by weight carbon fibrils.

19. A process for making a bilayered polymeric structure for packaging of electronic components which comprises:

10 (a) forming a first polymeric sheet from a first molten composition comprising a polymer comprising from 0.26% to 25% by weight of carbon fibrils;

(b) forming a second polymeric sheet from a second molten composition comprising a polymer comprising from 2% to 35% by weight of carbon fibrils; and

15 (c) combining said first and second sheet into said bilayered polymeric structure.

20. The process according to claim 19, wherein said layers are combined by lamination or coextrusion, or two shot or multi-shot injection molding or by insert injection molding.

21. The process according to claim 19, wherein said first and second molten compositions are allowed to become cured after step (c) or cured sequentially.

22. The process according to claim 19, further comprising adding a conductive adhesive between said first polymeric sheet and said second polymeric sheet.

25 23. A container for sensitive electrical components comprising:

(a) a first layer of polymeric material adapted to support an electrical component, said first polymeric layer comprising from about 0.25% to about 25% by weight carbon fibrils and having a resistivity in the range of from about 1×10^5 ohms per square to about 1×10^{12} ohms per square; and

5 (b) a second layer of polymeric material in surface contact with said first layer, said second layer forming the outer layer of said container comprising from about 2% to about 35% by weight carbon fibrils and having a resistivity in the range of from about 1×10^1 ohms per square to about 1×10^5 ohms per square.

24. The container of claim 23, further comprising at least an electrically 10 conductive material between said first polymeric layer and said second polymeric layer.

25. The container of claim 24, wherein the electrically conductive material is an adhesive.

26. The container of claim 23, wherein said first polymeric layer and said 15 second polymeric layer comprise a hybrid mixture of PETG and PBT said mixture comprising from about 0% to about 100% by weight PETG, the remaining portion being PBT.

27. The container of claim 23, further comprising a third polymeric layer 20 in surface contact with said first or said second layer of polymeric material, said third polymeric layer comprising from about 0.25% to about 35% by weight carbon fibrils and having a resistivity in the range from about 1×10^1 ohms per square to about 1×10^1 ohms per square,

28. A protective covering for an electrical current carrying cable comprising:

25 (a) a first layer of polymeric material adapted to support an electrical component, said first polymeric layer comprising from about 0.25% to about 25% by weight carbon fibrils and having a resistivity in the range of from about 1×10^5 ohms per square to about 1×10^{12} ohms per square; and

(b) a second layer of polymeric material in surface contact with said first layer, said second layer forming the outer layer of said container comprising from about 2% to about 35% by weight carbon fibrils and having a resistivity in the range of from about 1×10^1 ohms per square to about 1×10^6 ohms per square.

1 / 4

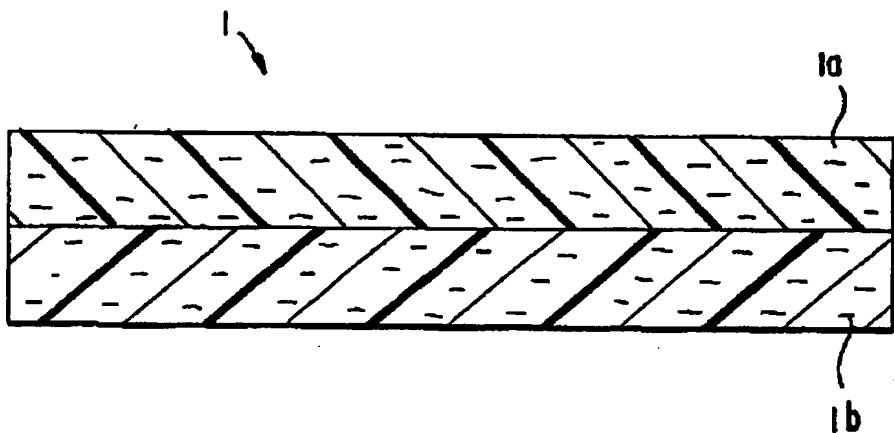


FIG. 1

2/4

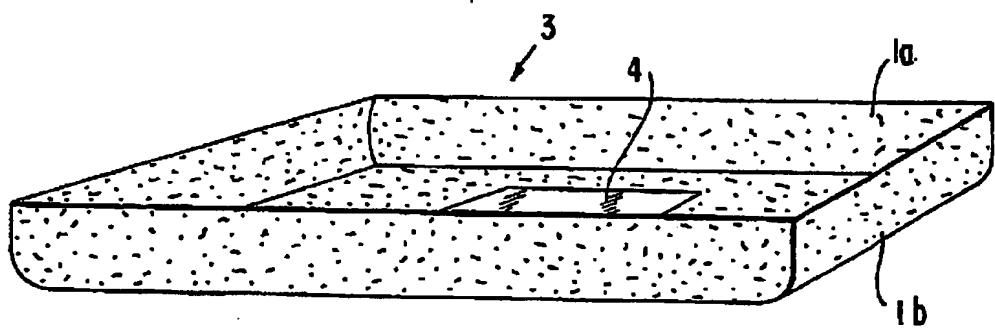


FIG. 2

WO 01/96100

PCT/US01/40978

3 / 4

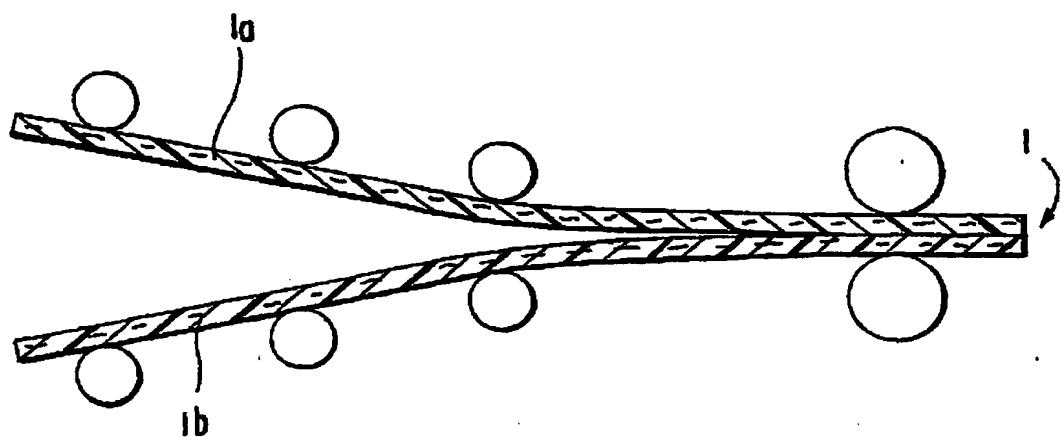


FIG. 3

4/4

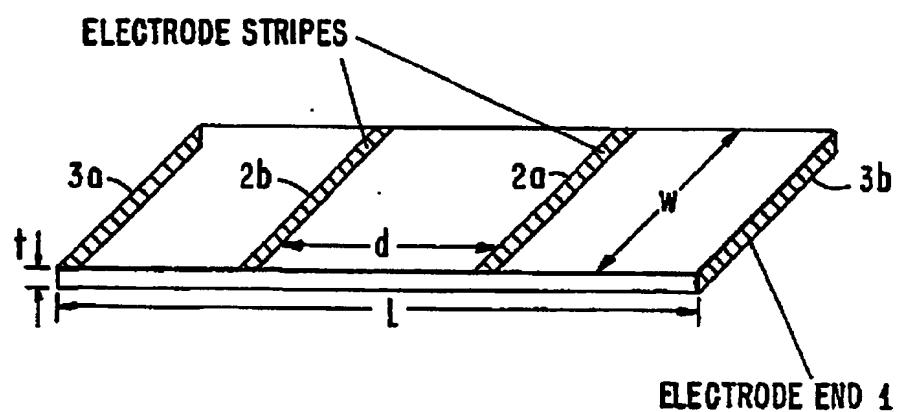


FIG. 4

INTERNATIONAL SEARCH REPORT

International application No.
PCT/US01/40978

A. CLASSIFICATION OF SUBJECT MATTER

IPC(7) : B32B 5/18, 7/02, 27/20; B65D 85/00, 85/86; H01B 1/18, 1/24
US CL : 428/55.7, 56.4, 411.1, 500, 515; 264/165, 179.18

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

U.S. : 428/55.7, 56.4, 411.1, 500, 515; 264/165, 179.18

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US 4,540,624 A (CANNADY, JR.) 10 September 1985, col. 1, lines 34-59, col. 2, lines 39-52, col. 3, lines 23-25, col. 4, lines 43-56, 65-66,	1-28
Y	US 5,908,585 A (SHIBUTA) 01 June 1999, col. 3, lines 45-67, col. 4, lines 20-24.	1-28
Y	JP 61160489 A (ZEON KASEI KK) 21 July 1986, abstract, page 3, paragraph 1, last.	1-28
Y	JP 11115985 A (KAKIZAKI SEISAKUSHO KK) 27 April 1999, abstract.	23-28

Further documents are listed in the continuation of Box C. See patent family annex.

* Special categories of cited documents:	"T"	later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
"A"		document defining the general state of the art which is not considered to be of particular relevance
"B"	"X"	earlier document published on or after the international filing date
"L"		document which may throw doubt on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)
"D"	"Y"	document referring to an oral disclosure, use, exhibition or other means
"P"	"R"	document published prior to the international filing date but later than the priority date claimed

Date of the actual completion of the international search 20 SEPTEMBER 2001	Date of mailing of the international search report 25 OCT 2001
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